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IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Inventor:	Chen et al	Confirmation No:	2353
Serial No.:	10/776,084	Examiner:	Trung Q Dang
Filed:	Feb 11, 2004	Group Art Unit:	2823
Title:	Wafer Packaging And Singulation Method		

Commissioner for Patents
P O BOX 1450
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RESPONSE TO RESTRICTION REQUIREMENT

In response to your Office Action/Restriction Requirement dated June 8, 2005; Applicants affirm the election of **Group I (Claims 1-49)** without traverse.

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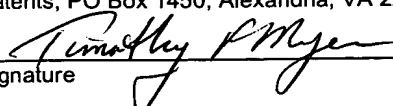
Respectfully submitted,

Chen et al

By:


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I hereby certify that this correspondence is being deposited on the date indicated below with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313.


Signature

Timothy F. Myers
Typed Name

6/17/05
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